

Electronic Patent Application Fee Transmittal

Application Number:	10581395
Filing Date:	
Title of Invention:	Chip scale package and method of assembling the same
First Named Inventor/Applicant Name:	Hien Boon Tan
Filer:	Carl Joseph Pellegrini/ruth swanson
Attorney Docket Number:	Q78657
Filed as Large Entity	

U.S. National Stage under 35 USC 371 Filing Fees

Description	Fee Code	Quantity	Amount	Sub-Total in USD(\$)
Basic Filing:				
Pages:				
Claims:				
Miscellaneous-Filing:				
Oath/decl > 30 months from priority date	1617	1	130	130

Petition:

Patent-Appeals-and-Interference:

Post-Allowance-and-Post-Issuance:

Extension-of-Time:

Description	Fee Code	Quantity	Amount	Sub-Total in USD(\$)
Extension - 2 months with \$0 paid	1252	1	460	460
Miscellaneous:				
Total in USD (\$)				590